

2SD1419

Silicon NPN Epitaxial

REJ03G0788-0200 (Previous ADE-208-1150) Rev.2.00 Aug.10.2005

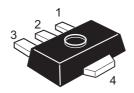
Application

- Low frequency power amplifier
- Complementary pair with 2SB1026

Outline

RENESAS Package code: PLZZ0004CA-A

(Package name: UPAK®)



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)

Note: Marking is "DE".

*UPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Symbol	Ratings	Unit
V_{CBO}	120	V
V_{CEO}	100	V
V_{EBO}	5	V
Ic	1	Α
i _{C(peak)} *1	2	А
P _C * ²	1	W
Tj	150	°C
Tstg	-55 to +150	°C
	V _{CBO} V _{CEO} V _{EBO} I _C i _{C(peak)} * ¹ P _C * ² Tj	$\begin{array}{c cccc} V_{CBO} & 120 \\ \hline V_{CEO} & 100 \\ \hline V_{EBO} & 5 \\ \hline I_{C} & 1 \\ \hline i_{C(peak)}^{*1} & 2 \\ \hline P_{C}^{*2} & 1 \\ \hline Tj & 150 \\ \hline \end{array}$

Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%

2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

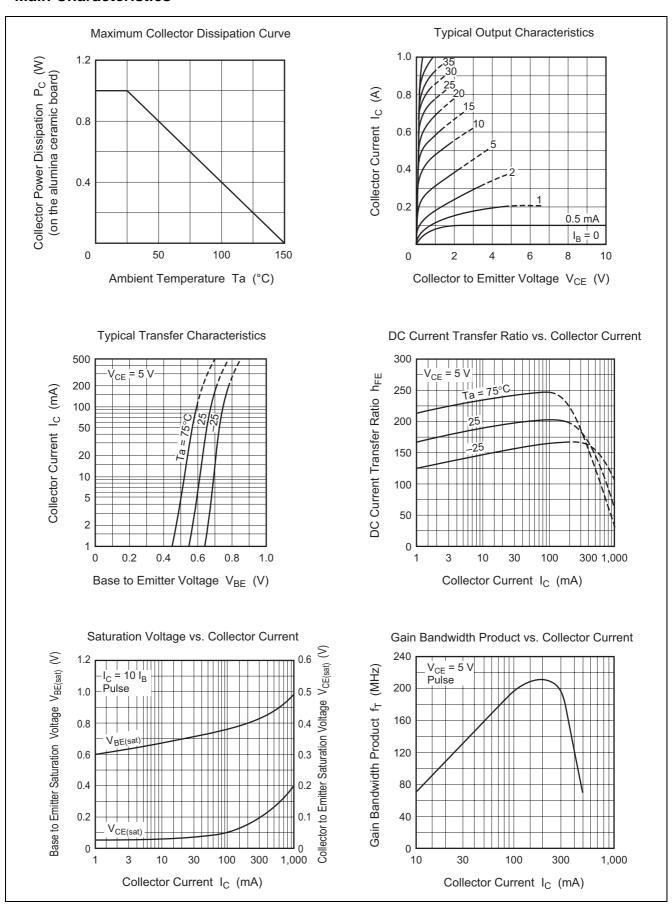
Electrical Characteristics

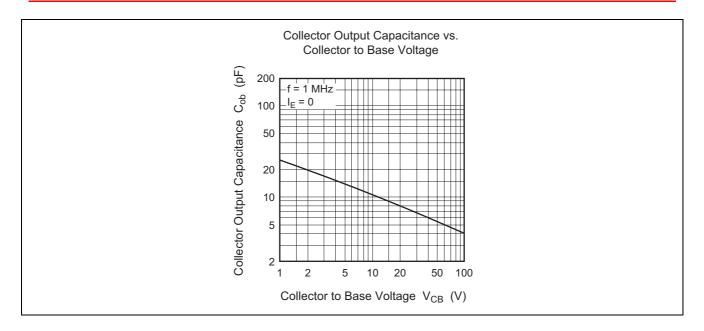
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	120	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	100	_	_	V	I_C = 1 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	10	μΑ	V _{CB} = 100 V, I _E = 0
DC current transfer ratio	h _{FE1}	100	_	200		$V_{CE} = 5 \text{ V}, I_{C} = 150 \text{ mA*}^{1}$
	h _{FE2}	30	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 500 \text{ mA*}^{1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	_	_	1	V	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}^{*1}$
Base to emitter voltage	V_{BE}	_	_	1.5	V	$V_{CE} = 5 \text{ V}, I_{C} = 150 \text{ mA*}^{1}$
Gain bandwidth product	f⊤		140	_	MHz	$V_{CE} = 5 \text{ V}, I_{C} = 150 \text{ mA*}^{1}$
Collector output capacitance	Cob		12	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$

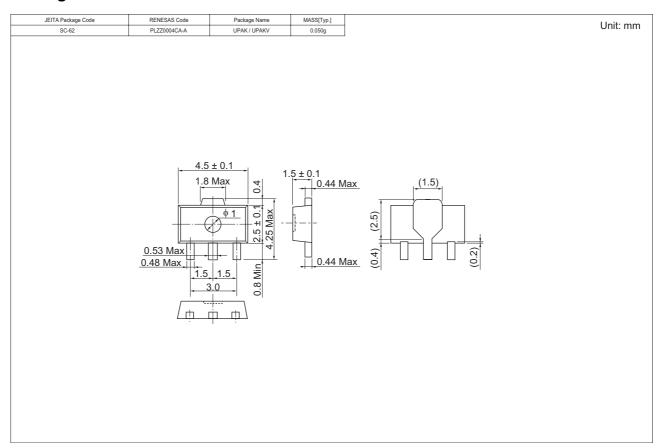
Notes: 1. Pulse test

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SD1419DETL-E	1000	φ 178 mm Reel, 12 mm Emboss Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.
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Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

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Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510